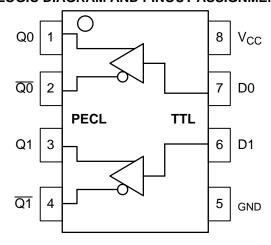
# **5V Dual TTL to Differential PECL Translator**

The MC10ELT/100ELT22 is a dual TTL to differential PECL translator. Because PECL (Positive ECL) levels are used only +5 V and ground are required. The small outline 8-lead package and the low skew, dual gate design of the ELT22 makes it ideal for applications which require the translation of a clock and a data signal.

- 1.2 ns Typical Propagation Delay
- <300 ps Typical Output to Output Skew
- PNP TTL Inputs for Minimal Loading
- Flow Through Pinouts
- ESD Protection: >2 KV HBM, >200 V MM
- Operating Range: V<sub>CC</sub>= 4.75 V to 5.25 V with GND= 0 V
- No Internal Input Pulldown Resistors
- Meets or Exceeds JEDEC Spec EIA/JESD78 IC Latchup Test
- Moisture Sensitivity Level 1
   For Additional Information, see Application Note AND8003/D
- Flammability Rating: UL-94 code V-0 @ 1/8", Oxygen Index 28 to 34
- Transistor Count = 51 devices

### LOGIC DIAGRAM AND PINOUT ASSIGNMENT



### **PIN DESCRIPTION**

PIN	FUNCTION
Qn, Qn	PECL Differential Outputs*
Dn	TTL Inputs
V <sub>CC</sub>	Positive Supply
GND	Ground

<sup>\*</sup> Output state undetermined when inputs are open.



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### MARKING DIAGRAMS\*



SO-8 D SUFFIX CASE 751









 $\begin{array}{lll} H = MC10 & L = Wafer Lot \\ K = MC100 & Y = Year \\ A = Assembly Location & W = Work Week \end{array}$ 

### ORDERING INFORMATION

Device	Package	Shipping
MC10ELT22D	SO-8	98 Units/Rail
MC10ELT22DR2	SO-8	2500 Tape & Reel
MC100ELT22D	SO-8	98 Units/Rail
MC100ELT22DR2	SO-8	2500 Tape & Reel
MC10ELT22DT	TSSOP-8	98 Units/Rail
MC10ELT22DTR2	TSSOP-8	2500 Tape & Reel
MC100ELT22DT	TSSOP-8	98 Units/Rail
MC100ELT22DTR2	TSSOP-8	2500 Tape & Reel

<sup>\*</sup>For additional information, see Application Note AND8002/D

### MAXIMUM RATINGS (Note 1.)

Symbol	Parameter	Condition 1	Condition 2	Rating	Units
V <sub>CC</sub>	Positive Power Supply	GND = 0 V		7	V
V <sub>IN</sub>	Input Voltage	GND = 0 V	$V_{I} \leq V_{CC}$	7	V
l <sub>out</sub>	Output Current	Continuous Surge		50 100	mA mA
TA	Operating Temperature Range			-40 to +85	°C
T <sub>stg</sub>	Storage Temperature Range			-65 to +150	°C
$\theta_{JA}$	Thermal Resistance (Junction to Ambient)	0 LFPM 500 LFPM	8 SOIC 8 SOIC	190 130	°C/W
$\theta_{\sf JC}$	Thermal Resistance (Junction to Case)	std bd	8 SOIC	41 to 44	°C/W
$\theta_{JA}$	Thermal Resistance (Junction to Ambient)	0 LFPM 500 LFPM	8 TSSOP 8 TSSOP	185 140	°C/W
θЈС	Thermal Resistance (Junction to Case)	std bd	8 TSSOP	41 to 44 ± 5%	°C/W
T <sub>sol</sub>	Wave Solder	<2 to 3 sec @ 248°C		265	°C

<sup>1.</sup> Maximum Ratings are those values beyond which device damage may occur.

### **10ELT SERIES PECL DC CHARACTERISTICS** $V_{CC} = 5.0 \text{ V}$ ; GND = 0.0 V (Note 1.)

		-40°C 25°C		85°C							
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I <sub>CC</sub>	Power Supply Current			22			22			22	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 2.)	3920	4010	4110	4020	4105	4190	4090	4185	4280	mV
V <sub>OL</sub>	Output LOW Voltage (Note 2.)	3050	3200	3350	3050	3210	3370	3050	3227	3405	mV

NOTE: Devices are designed to meet the DC specifications shown in the above table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained.

- 1. Output parameters vary 1:1 with  $V_{CC}$ .  $V_{CC}$  can vary  $\pm$  0.25 V.
- 2. Outputs are terminated through a 50 ohm resistor to  $V_{\mbox{\footnotesize CC}}$ -2 volts.

### 100ELT SERIES PECL DC CHARACTERISTICS $V_{CC} = 5.0 \text{ V}$ ; GND = 0.0 V (Note 1.)

		−40°C 25°C		85°C							
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
Icc	Power Supply Current			22			22			22	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 2.)	3915	3995	4120	3975	4045	4120	3975	4050	4120	mV
V <sub>OL</sub>	Output LOW Voltage (Note 2.)	3170	3305	3445	3190	3295	3380	3190	3295	3380	mV

NOTE: Devices are designed to meet the DC specifications shown in the above table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained.

- 1. Output parameters vary 1:1 with V  $_{CC}.$  V  $_{CC}$  can vary  $\pm$  0.25 V.
- 2. Outputs are terminated through a 50 ohm resistor to  $V_{\mbox{CC}}$ -2 volts.

TTL INPUT DC CHARACTERISTICS  $V_{CC}$  = 4.75 V to 5.25 V;  $T_A$  = -40°C to 85°C

Symbol	Characteristic	Condition	Min	Тур	Max	Unit
I <sub>IH</sub>	Input HIGH Current	V <sub>IN</sub> = 2.7 V			20	μΑ
I <sub>IHH</sub>	Input HIGH Current	V <sub>IN</sub> = 7.0 V			100	μΑ
I <sub>IL</sub>	Input LOW Current	V <sub>IN</sub> = 0.5 V			-0.6	mA
V <sub>IK</sub>	Input Clamp Diode Voltage	I <sub>IN</sub> = -18 mA			-1.2	V
V <sub>IH</sub>	Input HIGH Voltage		2.0			V
V <sub>IL</sub>	Input LOW Voltage				0.8	V

### AC CHARACTERISTICS $\mbox{V}_{CC}\mbox{=}~4.75\mbox{ V to }5.25\mbox{ V; GND=}~0.0\mbox{ V}$

			–40°C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
f <sub>MAX</sub>	Maximum Input Frequency	100			100			100			MHz
t <sub>PLH</sub>	Propagation Delay (Note 1.) 1.5 V to 50%	0.6		1.2	0.9	1.2	1.5	0.6		1.35	ns
t <sub>PHL</sub>	Propagation Delay (Note 1.) 1.5 V to 50%	0.4		1.0	0.5	0.8	1.1	0.7		1.30	ns
t <sub>JITTER</sub>	Cycle-to-Cycle Jitter			TBD	TBD			TBD			ps
t <sub>r</sub> /t <sub>f</sub>	Output Rise/Fall Time (20–80%)	0.4		1.6	0.4		1.6	0.4		1.6	ns

<sup>1.</sup> Specifications for standard TTL input signal.

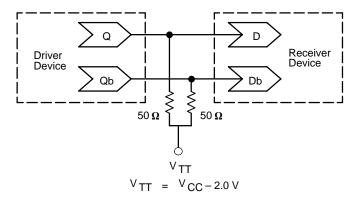


Figure 1. Typical Termination for Output Driver and Device Evaluation (See Application Note AND8020 – Termination of ECL Logic Devices.)

### **Resource Reference of Application Notes**

AN1400 – MC10/100H640 Clock Driver Family I/O SPICE Modeling Kit

AN1404 – ECLinPS Circuit Performance at Non–Standard V<sub>IH</sub> Levels

AN1405 – ECL Clock Distribution Techniques
AN1406 – Designing with PECL (ECL at +5.0 V)

AN1503 – ECLinPS I/O SPICE Modeling Kit

AN1504 — Metastability and the ECLinPS Family

AN1560 – Low Voltage ECLinPS SPICE Modeling Kit

AN1568 – Interfacing Between LVDS and ECL

AN1596 – ECLinPS Lite Translator ELT Family SPICE I/O Model Kit

AN1650 – Using Wire–OR Ties in ECLinPS Designs

AN1672 – The ECL Translator Guide

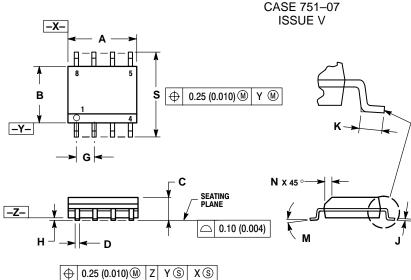
AND8001 – Odd Number Counters Design

AND8002 — Marking and Date Codes

AND8020 - Termination of ECL Logic Devices

### **PACKAGE DIMENSIONS**

### SO-8 **D SUFFIX** PLASTIC SOIC PACKAGE CASE 751-07

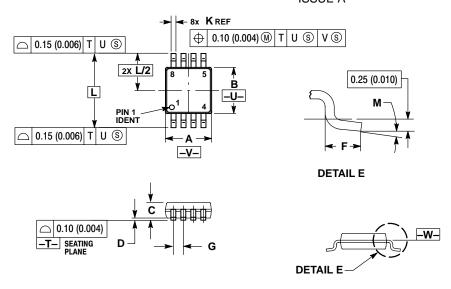


- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.
  3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
  4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE
- 4. MAXIMUM MOLD PHOTHUSION 0.15 (0.006) PER SIDE.
  5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIMETERS		INC	HES	
DIM	MIN	MAX	MIN	MAX	
Α	4.80	5.00	0.189	0.197	
В	3.80	4.00	0.150	0.157	
С	1.35	1.75	0.053	0.069	
D	0.33	0.51	0.013	0.020	
G	1.27	7 BSC	0.050 BSC		
Н	0.10	0.25	0.004	0.010	
J	0.19	0.25	0.007	0.010	
K	0.40	1.27	0.016	0.050	
M	0 °	8 °	0 °	8 °	
N	0.25	0.50	0.010	0.020	
S	5.80	6.20	0.228	0.244	

### **PACKAGE DIMENSIONS**

### TSSOP-8 **DT SUFFIX** PLASTIC TSSOP PACKAGE CASE 948R-02 **ISSUE A**



### NOTES:

- OTES:

  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

  2. CONTROLLING DIMENSION: MILLIMETER.

  3. DIMENSION A DOES NOT INCLUDE MOLD FLASH. PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.

  4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.

  5. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
- REFERENCE ONLY.

  6. DIMENSION A AND B ARE TO BE
  DETERMINED AT DATUM PLANE -W-.

	MILLIN	IETERS	INCHES			
DIM	MIN	MAX	MIN	MAX		
Α	2.90	3.10	0.114	0.122		
В	2.90	3.10	0.114	0.122		
С	0.80	1.10	0.031	0.043		
D	0.05	0.15	0.002	0.006		
F	0.40	0.70	0.016	0.028		
G	0.65	0.65 BSC 0.02		BSC		
K	0.25	0.40	0.010	0.016		
L	4.90	BSC	0.193	BSC		
М	0 °	6 °	0 °	6°		



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